Transmitted herewith for filing is the Patent Application of:

Inventor: TAI-CHUN HUANG, CHIH-HSIANG YAO, KUAN-SHOU CHI

For: NON-REPEATED AND NON-UNIFORM WIDTH SEAL RING STRUCTURE

Enclosed are:							
х	4 sheets of drawing(s) - formal.						
X	An assignment of the invention to Taiwan Semiconductor Manufacturing Co.						
	An associate power of attorney Applicant claims small entity status						
	Request & Certification under 35 USC 122(b)(2)(b)(i)						
The filing fee has been calculated as shown below:							
•		(Col. 1)	(Col. 2)	OTHER THAN	A SMALL ENTITY		
FOR:		NO. FILED	NO. EXTRA	RATE	FEE		
BASIC FEE		><	$>\!\!<$		<b>\$</b> 770.		
TOTA	L CLAIMS	<b>25 -</b> 20=	5	x 18 =	\$ 90.		
INDEF	CLAIMS	3 -3=	0	x 86 =	\$ 0.		
				SUB TOTAL	\$ 860.		
				ASSIGNMENT	<b>\$40</b> .		
				TOTAL	\$ 900.		
X	Please charge my Deposit Account No. 19-0033 in the amount of \$ 900. A duplicate copy of this sheet is enclosed.						
x	The Commiss	The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any					
overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.  X Any additional filing fees required under 37 CFR §1.16.							
	X Any patent application processing fees under 37 CFR §1.17.						
	Respectfully submitted,						

## **EXPRESS MAIL CERTIFICATE**

EN B. ACKERMAN, REG. NO. 37,761

Express Mail No.EV385357757US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Date of deposit